TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSIII)

2SK2718

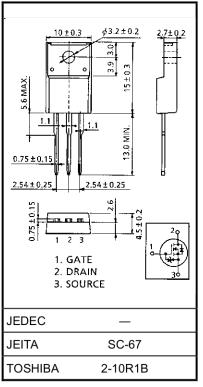
DC-DC Converter and Motor Drive Applications

Unit: mm

 $\begin{array}{ll} \bullet & Low \ drain-source \ ON \ resistance & : \ RDS \ (ON) = 5.6 \ \Omega \ (typ.) \\ \bullet & High \ forward \ transfer \ admittance & : \ |Y_{fs}| = 2.0 \ S \ (typ.) \\ \bullet & Low \ leakage \ current & : \ IDSS = 100 \ \mu A \ (max) \ (VDS = 720 \ V) \\ \bullet & Enhancement \ mode & : \ V_{th} = 2.0 \sim 4.0 \ V \ (VDS = 10 \ V, \ ID = 1 \ mA) \\ \end{array}$

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	900	V	
Drain-gate voltage (R _{GS} = 20 kΩ)		V_{DGR}	900	V	
Gate-source voltage		V _{GSS}	±30	V	
Drain current	DC (Note 1)	ID	2.5	Α	
	Pulse (Note 1)	I _{DP}	7.5	Α	
Drain power dissipation	n (Tc = 25°C)	P _D	40	W	
Single pulse avalanche energy (Note 2)		E _{AS}	216	mJ	
Avalanche current		I _{AR}	2.5	Α	
Repetitive avalanche e	nergy (Note 3)	E _{AR}	4.0	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature ra	ange	T _{stg}	-55~150	°C	



Weight: 1.9 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

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Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	3.125	°C / W
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C / W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 63.4 mH, R_G = 25 Ω , I_{AR} = 2.5 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device.

Please handle with caution.

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Electrical Characteristics (Ta = 25°C)

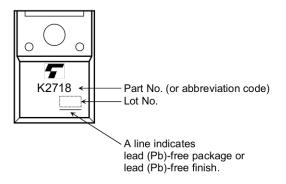
Charac	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I _{GSS}	V _{GS} = ±25 V, V _{DS} = 0 V	_	_	±10	μΑ
Gate-source bre	eakdown voltage	V (BR) GSS	I _G = ±10 μA, V _{DS} = 0 V	±30	_	_	V
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = 720 V, V _{GS} = 0 V	_	_	100	μΑ
Drain-source br	eakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	900	_	_	V
Gate threshold v	oltage/	V_{th}	V _{DS} = 10 V, I _D = 1 mA	2.0	_	4.0	V
Drain-source O	N resistance	R _{DS (ON)}	V _{GS} = 10 V, I _D = 1.5 A	_	5.6	6.4	Ω
Forward transfe	r admittance	Y _{fs}	V _{DS} = 20 V, I _D = 1.5 A	1.0	2.0	_	S
Input capacitano	e	C _{iss}		_	510	_	
Reverse transfe	r capacitance	C _{rss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz		10	_	pF
Output capacitance		C _{oss}			55	_	
Switching time	Rise time	t _r	V_{GS} V_{OV} V_{OUT} V_{OUT} V_{OUT} V_{OUT} V_{DD} v_{DD}	_	20	_	
	Turn-on time	t _{on}		_	60	_	ne
	Fall time	t _f		_	40	_	ns i
	Turn-off time	t _{off}	Duty $\leq 1\%$, $t_{\rm W} = 10 \mu \rm s$	_	115	_	
Total gate charg plus gate-drain)	al gate charge (gate-source gate-drain)		_	21	_	nC	
Gate-source charge		Q _{gs}	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 2.5 \text{ A}$		11		_
Gate-drain ("miller") Charge		Q _{gd}			10		_

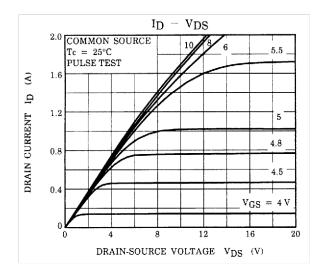
Source-Drain Ratings and Characteristics (Ta = 25°C)

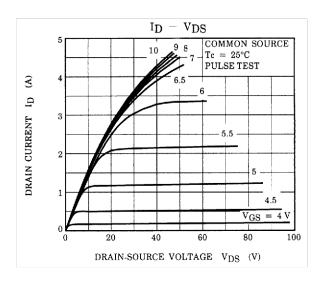
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	2.5	А
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	7.5	А
Forward voltage (diode)	V _{DSF}	I _{DR} = 2.5 A, V _{GS} = 0 V		_	-2.0	V
Reverse recovery time		I _{DR} = 2.5 A, V _{GS} = 0 V		960	_	ns
Reverse recovery charge	Qrr	dl _{DR} / dt = 100 A / μs	_	5.3	_	μC

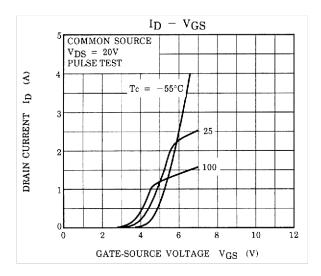
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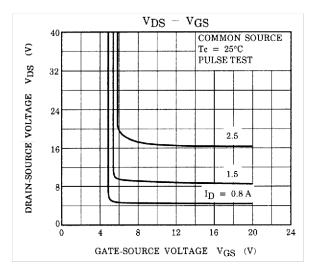
Marking

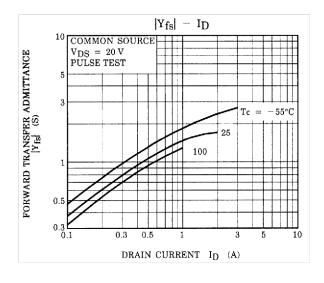


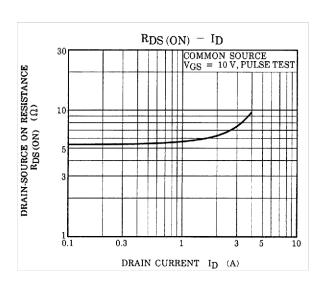


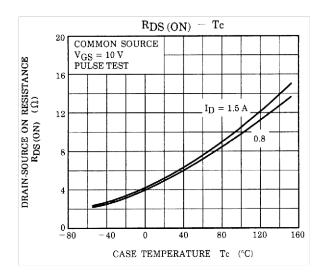


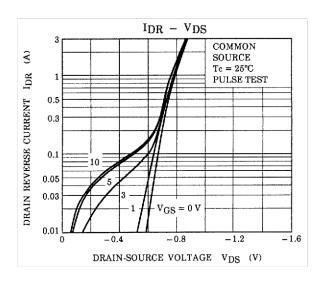


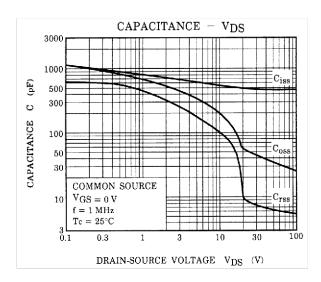


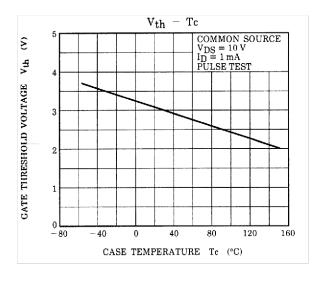


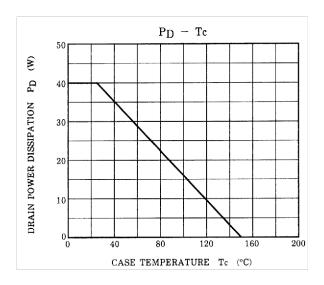


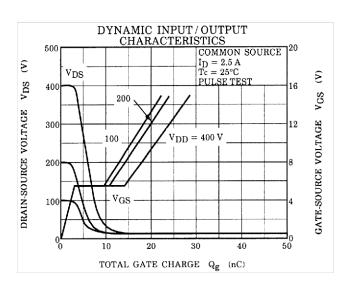


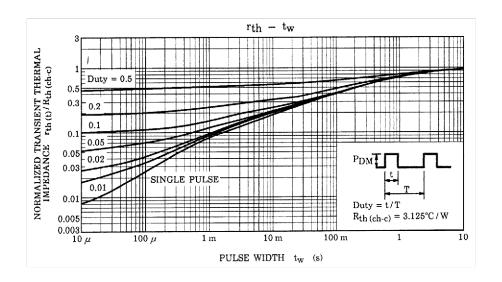


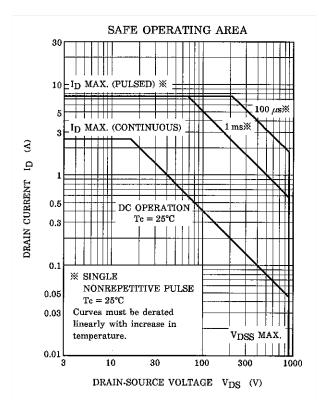


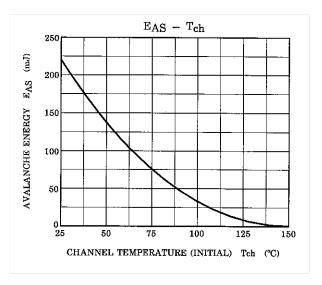


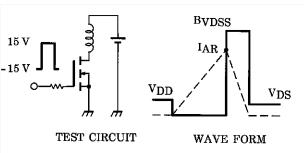












$$R_G = 25 \Omega$$

 $V_{DD} = 90 \text{ V}, L = 63.4 \text{ mH}$

$$EAS = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{BVDSS}{BVDSS - VDD} \right)$$

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20070701-EN

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